



### 100V N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	Package	I <sub>D</sub> T <sub>C</sub> = +25°C	
100V	$9.5 m\Omega @V_{GS} = 10V$	TO220AB	98A	

## **Description**

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high-efficiency power management applications.

### **Applications**

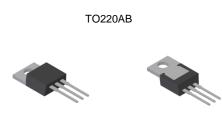
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

### **Features**

- Low Input Capacitance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

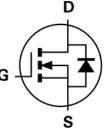
### **Mechanical Data**

- Case: TO220AB
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 <sup>®</sup>
- Terminal Connections: See Diagram Below
- Weight: TO220AB 1.85 grams (Approximate)

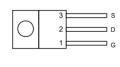


Top View

Bottom View



**Equivalent Circuit** 



Top View Pin Out Configuration

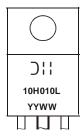
## Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H010LCT	TO220AB	50 Pieces/Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine 1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



Old = Manufacturer's Marking
10H010L = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 16 = 2016)
WW or WW = Week Code (01 to 53)



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage	$V_{DSS}$	100	V	
Gate-Source Voltage		$V_{GSS}$	±20	V
Continuous Drain Current	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	l <sub>D</sub>	98 62	А
Maximum Continuous Body Diode Forward Current	T <sub>C</sub> = +25°C	Is	90	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	92	Α
Avalanche Current, L=0.3mH (Note 7)	I <sub>AS</sub>	10	Α	
Avalanche Energy, L=0.3mH (Note 7)		Eas	15	mJ

## **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	$T_A = +25$ °C	$P_{D}$	2	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	61	°C/W
Total Power Dissipation	$T_C = +25^{\circ}C$	$P_{D}$	139	W
Thermal Resistance, Junction to Case		$R_{ heta JC}$	0.9	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

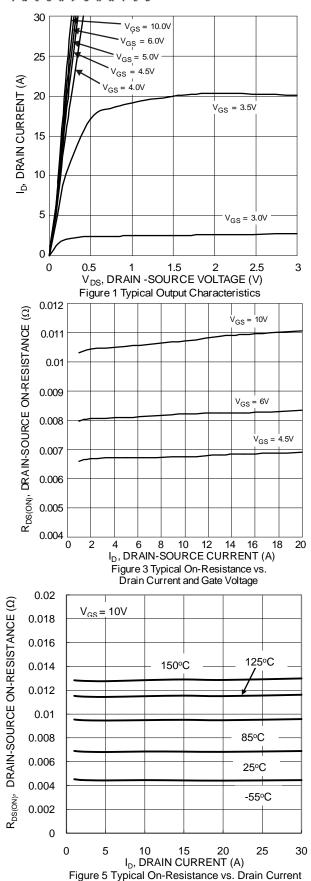
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$		
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$		
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.4	1.9	3.0	٧	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		
		-	6.9	9.5		$V_{GS} = 10V, I_D = 13A$		
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	8	12	mΩ	$V_{GS} = 6V, I_D = 13A$		
	' '	_	10	20		$V_{GS} = 4.5V, I_D = 5A$		
Diode Forward Voltage	$V_{SD}$	_	0.8	1.3	V	$V_{GS} = 0V, I_{S} = 13A$		
DYNAMIC CHARACTERISTICS (Note 7)								
Input Capacitance	C <sub>iss</sub>	_	2592	_		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz		
Output Capacitance	Coss	_	792	_	pF			
Reverse Transfer Capacitance	C <sub>rss</sub>	1	45	_		1 - 1101112		
Gate Resistance	R <sub>G</sub>		2	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$		
Total Gate Charge	$Q_{G}$	_	53.7	_		$V_{DD} = 50V, I_D = 13A,$ $V_{GS} = 10V$		
Gate-Source Charge	$Q_{GS}$	_	10.6	_	nC			
Gate-Drain Charge	$Q_{GD}$	_	8.2	_				
Turn-On Delay Time	t <sub>D(ON)</sub>	_	11.6	_		V <sub>DD</sub> = 50V, V <sub>GS</sub> = 10V,		
Turn-On Rise Time	t <sub>R</sub>	_	14.1	_				
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	42.9	_	ns	$I_D = 13A$ , $R_G = 6\Omega$		
Turn-Off Fall Time	t <sub>F</sub>	_	22	_				
Reverse Recovery Time	t <sub>RR</sub>	_	49.8	_	ns	1 424 4:/4+ 4004/		
Reverse Recovery Charge	$Q_{RR}$	_	85.1	_	$I_F = 13A$ , di/dt = 100A/ $\mu$ s			

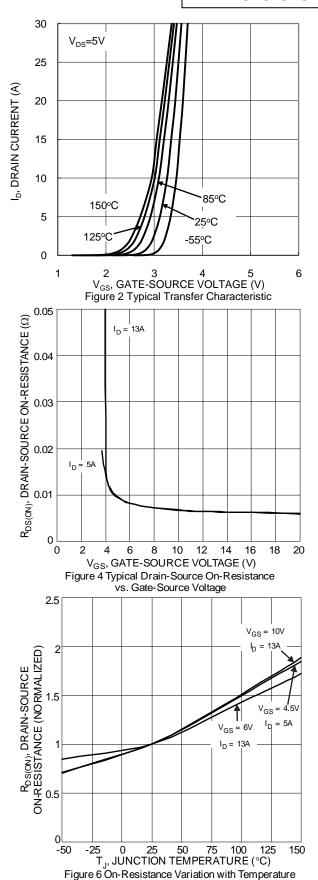
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

<sup>6.</sup> Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing.





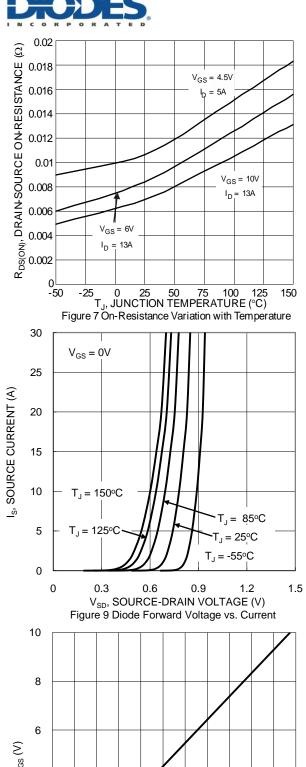


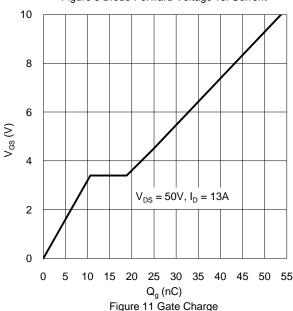


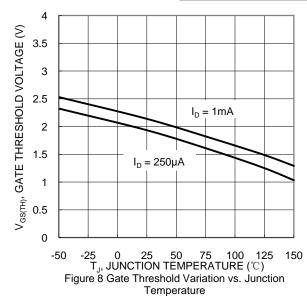
and Junction Temperature

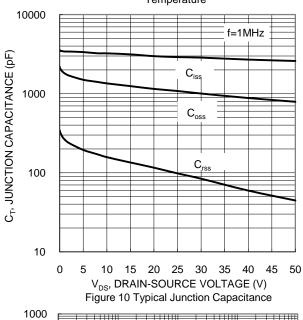


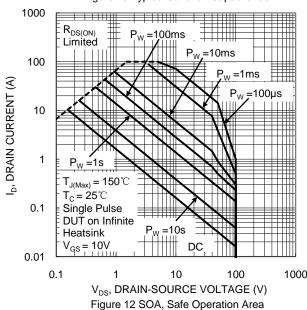














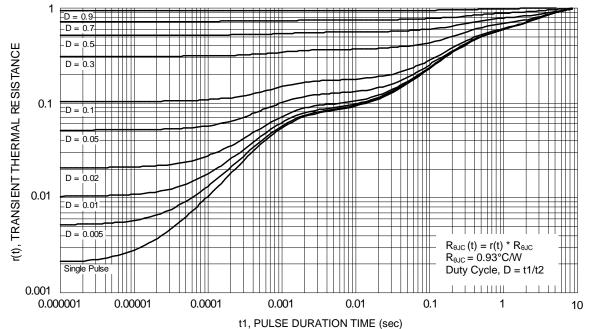


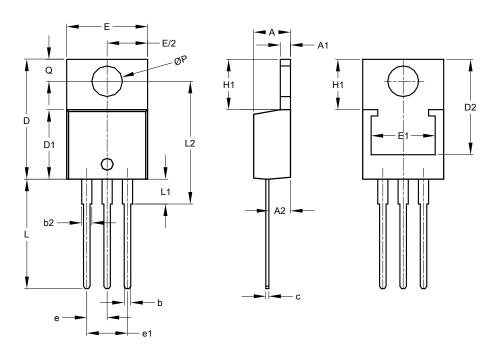
Figure 13 Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **TO220AB**



TO220AB					
Dim	Min	Max	Тур		
Α	3.56	4.82	_		
<b>A</b> 1	0.51	1.39	_		
A2	2.04	2.92	_		
b	0.39	1.01	0.81		
b2	1.15	1.77	1.24		
C	0.356	0.61	_		
D	14.22	16.51	_		
D1	8.39	9.01	_		
D2	11.45	12.87	_		
е	_	_	2.54		
e1	_	_	5.08		
Е	9.66	10.66	_		
E1	6.86	8.89	_		
H1	5.85	6.85	_		
ᆚ	12.70	14.73	_		
L1	_	6.35	_		
L2	15.80	16.20	16.00		
Р	3.54	4.08	_		
ø	2.54	3.42	_		
All Dimensions in mm					



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